

Leadless NTC Thermistor Die Suitable for Wire Bonding



FEATURES

- Flat chip contacted top and bottom (gold: NTCC300E4 series or silver: NTCC200E4 series)
- Wide temperature range from -55 °C to +175 °C
- Highly resistant to thermal shocks
- Ideal for wire bonding (aluminum or gold depending on metallization type)
- Resistance to leaching
- Delivered on blister tape
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

QUICK REFERENCE DATA		
PARAMETER	VALUE	UNIT
Resistance value at 25 °C	4.7K to 20K	Ω
Tolerance on R_{25} -value	± 1 to ± 5	%
$B_{25/85}$ -value	3435 to 3865	K
Tolerance on $B_{25/85}$ -value	± 1	%
Operating temperature range	-55 to +175	°C
Response time (63.2 %) 25 °C to 85 °C still air (for info)	3	s
Dissipation factor δ in still air (for info, non-mounted die)	3	mW
Maximum power dissipation	50	mW
Weight	3	mg

DIMENSIONS in millimeters	
<p>■ Wire bondable surface</p>	
PARAMETER	VALUE
W	2 ± 0.1
T	0.7 max.

Note

- Non-dimensioned details do not affect the performance of the thermistors.

APPLICATIONS

- High temperature sensing, control and compensation. E.g. IGBT modules (inverters in EV and HEV vehicles)
- IC and semiconductor protecting
- DC/AC power inverters and HIC overheat protecting

MOUNTING

The thermistors are primarily intended for wire bonding. The parameters of the assembly process should be chosen in accordance with the lead-wire material.

The mounting process should be in compliance with the following guidelines and recommendations:

Die bonding:

- Gold electrode: silver epoxy gluing.
- Silver electrode: (vacuum) reflow soldering - silver epoxy gluing - nano silver sintering.

Cleaning:

- Detergent spraying.
- Ultrasonic cleaning is not recommended.

Wire bonding:

- The gold electrode has been tested for gold wire bonding with a wire diameter of max. 32 μm.
- The silver electrode has been tested for aluminium wire bonding with a wire diameter of max. 300 μm.

Encapsulation:

- In order to preserve the characteristics of the bonded die at long term an encapsulation is mandatory.
- The encapsulation is defined by the user. Silicon and epoxy encapsulations have been tested. For recommendations on compatible encapsulants contact Vishay.

ELECTRICAL DATA AND ORDERING INFORMATION					
VISHAY SAP ORDERING NUMBER (1)	R_{25} -VALUE (kΩ)	ΔR_{25} -VALUE (%)	$B_{25/85}$ -VALUE (K)	$B_{25/85}$ -TOL. (%)	DESCRIPTION
NTCC200E4472*T	4.7	1, 2, 3, 5	3435	1	Bare die with top /bottom silver terminations
NTCC200E4123*T	12	1, 2, 3, 5	3740	1	Bare die with top /bottom silver terminations
NTCC200E4203*T	20	1, 2, 3, 5	3865	1	Bare die with top /bottom silver terminations
NTCC300E4472*T	4.7	1, 2, 3, 5	3435	1	Bare die with top /bottom gold terminations
NTCC300E4123*T	12	1, 2, 3, 5	3740	1	Bare die with top /bottom gold terminations
NTCC300E4203*T	20	1, 2, 3, 5	3865	1	Bare die with top /bottom gold terminations

Note

- (1) In order to define R_{25} -tolerance, replace * in SAP part number by F (± 1 %), G (± 2 %), H (± 3 %) of J (± 5 %).



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.